74AVC1T45Dual-supply voltage level translator/transceiver; 3-stateRev. 4 - 22 June 2012Product data sheet

### 1. General description

The 74AVC1T45 is a single bit, dual supply transceiver with 3-state output that enables bidirectional level translation. It features two 1-bit input-output ports (A and B), a direction control input (DIR) and dual supply pins ( $V_{CC(A)}$  and  $V_{CC(B)}$ ). Both  $V_{CC(A)}$  and  $V_{CC(B)}$  can be supplied at any voltage between 0.8 V and 3.6 V making the device suitable for translating between any of the low voltage nodes (0.8 V, 1.2 V, 1.5 V, 1.8 V, 2.5 V and 3.3 V). Pins A and DIR are referenced to  $V_{CC(A)}$  and pin B is referenced to  $V_{CC(B)}$ . A HIGH on DIR allows transmission from A to B and a LOW on DIR allows transmission from B to A.

The device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing any damaging backflow current through the device when it is powered down. In suspend mode when either  $V_{CC(A)}$  or  $V_{CC(B)}$  are at GND level, both A and B are in the high-impedance OFF-state.

### 2. Features and benefits

- Wide supply voltage range:
  - V<sub>CC(A)</sub>: 0.8 V to 3.6 V
  - V<sub>CC(B)</sub>: 0.8 V to 3.6 V
- High noise immunity
- Complies with JEDEC standards:
  - JESD8-12 (0.8 V to 1.3 V)
  - JESD8-11 (0.9 V to 1.65 V)
  - JESD8-7 (1.2 V to 1.95 V)
  - ◆ JESD8-5 (1.8 V to 2.7 V)
  - JESD8-B (2.7 V to 3.6 V)
- ESD protection:
  - ◆ HBM JESD22-A114E Class 3B exceeds 8000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101C exceeds 1000 V
- Maximum data rates:
  - 500 Mbit/s (1.8 V to 3.3 V translation)
  - 320 Mbit/s (< 1.8 V to 3.3 V translation)</li>
  - 320 Mbit/s (translate to 2.5 V or 1.8 V)
  - 280 Mbit/s (translate to 1.5 V)
  - 240 Mbit/s (translate to 1.2 V)
- Suspend mode
- Latch-up performance exceeds 100 mA per JESD 78 Class II



### Dual-supply voltage level translator/transceiver; 3-state

- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V<sub>CC</sub>
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

# 3. Ordering information

### Table 1.Ordering information

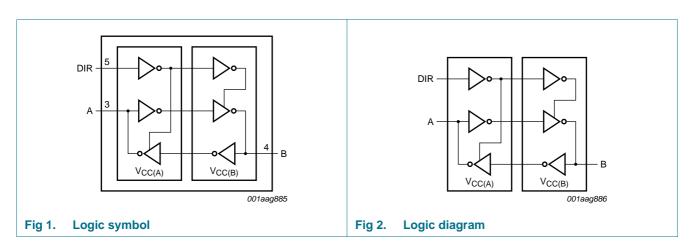
Type number	Package	Package						
	Temperature range	Name	Description	Version				
74AVC1T45GW	–40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363				
74AVC1T45GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1.45 $\times$ 0.5 mm	SOT886				
74AVC1T45GN	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm	SOT1115				
74AVC1T45GS	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $1.0 \times 1.0 \times 0.35$ mm	SOT1202				

### 4. Marking

Table 2. Marking	
Type number	Marking code <sup>[1]</sup>
74AVC1T45GW	B5
74AVC1T45GM	B5
74AVC1T45GN	B5
74AVC1T45GS	B5

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

# 5. Functional diagram

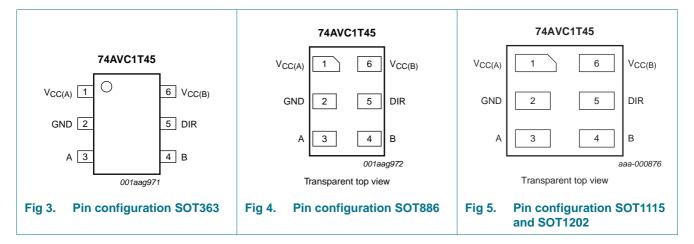


74AVC1T45 Product data sheet

Dual-supply voltage level translator/transceiver; 3-state

### 6. Pinning information

### 6.1 Pinning



### 6.2 Pin description

Table 3.	Pin description	
Symbol	Pin	Description
V <sub>CC(A)</sub>	1	supply voltage port A and DIR
GND	2	ground (0 V)
А	3	data input or output
В	4	data input or output
DIR	5	direction control
V <sub>CC(B)</sub>	6	supply voltage port B

# 7. Functional description

### Table 4.Function table<sup>[1]</sup>

Supply voltage	Input	Input/output <sup>[2]</sup>			
V <sub>CC(A)</sub> , V <sub>CC(B)</sub>	DIR <sup>[3]</sup>	Α	В		
0.8 V to 3.6 V	L	A = B	input		
0.8 V to 3.6 V	Н	input	B = A		
GND <sup>[4]</sup>	Х	Z	Z		

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

[2] The input circuit of the data I/O is always active.

[3] The DIR input circuit is referenced to  $V_{CC(A)}$ .

[4] When either  $V_{CC(A)}$  or  $V_{CC(B)}$  is at GND level, the device goes into suspend mode.

Dual-supply voltage level translator/transceiver; 3-state

### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC(A)</sub>	supply voltage A		-0.5	+4.6	V
V <sub>CC(B)</sub>	supply voltage B		-0.5	+4.6	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < 0 V	-50	-	mA
Vo	output voltage	Active mode	<u>[1][2][3]</u> –0.5	$V_{CCO}$ + 0.5	V
		Suspend or 3-state mode	<u>[1]</u> –0.5	+4.6	V
lo	output current	$V_{O} = 0 V$ to $V_{CCO}$	-	±50	mA
I <sub>CC</sub>	supply current	I <sub>CC(A)</sub> or I <sub>CC(B)</sub>	-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb}$ = -40 °C to +125 °C	<u>[4]</u> _	250	mW

[1] The minimum input voltage ratings and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] V<sub>CCO</sub> is the supply voltage associated with the output port.

[3]  $V_{CCO}$  + 0.5 V should not exceed 4.6 V.

### 9. Recommended operating conditions

#### Table 6. Recommended operating conditions

Parameter	Conditions	Min	Max	Unit
supply voltage A		0.8	3.6	V
supply voltage B		0.8	3.6	V
input voltage		0	3.6	V
output voltage	Active mode	<u>[1]</u> 0	V <sub>cco</sub>	V
	Suspend or 3-state mode	0	3.6	V
ambient temperature		-40	+125	°C
input transition rise and fall rate	$V_{CCI} = 0.8 V \text{ to } 3.6 V$	[2] _	5	ns/V
	supply voltage A supply voltage B input voltage output voltage ambient temperature	supply voltage A supply voltage B input voltage output voltage Active mode Suspend or 3-state mode ambient temperature	supply voltage A     0.8       supply voltage B     0.8       input voltage     0       output voltage     0       supply voltage     0       ambient temperature     -40	supply voltage A0.83.6supply voltage B0.83.6input voltage03.6output voltage03.6Suppend or 3-state mode110with temperature-40+125

[1]  $V_{CCO}$  is the supply voltage associated with the output port.

[2] V<sub>CCI</sub> is the supply voltage associated with the input port.

Dual-supply voltage level translator/transceiver; 3-state

### **10. Static characteristics**

#### Table 7. Typical static characteristics at $T_{amb} = 25 \text{ °C} \frac{[1][2]}{2}$

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

	, ,					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>OH</sub>	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O} = -1.5 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 0.8 \text{ V}$	-	0.69	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O}$ = 1.5 mA; $V_{CC(A)} = V_{CC(B)} = 0.8$ V	-	0.07	-	V
l <sub>l</sub>	input leakage current	DIR input; V <sub>I</sub> = 0 V or 3.6 V; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 0.8 V to 3.6 V	-	±0.025	±0.25	μA
I <sub>OZ</sub>	OFF-state output current	A or B port; $V_O = 0$ V or $V_{CCO}$ ; $V_{CC(A)} = V_{CC(B)} = 0.8$ V to 3.6 V	<u>[3]</u> _	±0.5	±2.5	μA
I <sub>OFF</sub>	power-off leakage current	A port; V <sub>1</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC(A)</sub> = 0 V; V <sub>CC(B)</sub> = 0.8 V to 3.6 V	-	±0.1	±1	μA
		B port; V <sub>1</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC(B)</sub> = 0 V; V <sub>CC(A)</sub> = 0.8 V to 3.6 V	-	±0.1	±1	μΑ
CI	input capacitance	DIR input; $V_1 = 0 V \text{ or } 3.3 V$ ; $V_{CC(A)} = V_{CC(B)} = 3.3 V$	-	1.0	-	рF
C <sub>I/O</sub>	input/output capacitance	A and B port; Suspend mode; $V_O = V_{CCO}$ or GND; $V_{CC(A)} = V_{CC(B)} = 3.3 \text{ V}$	-	4.0	-	pF

[1]  $V_{CCO}$  is the supply voltage associated with the output port.

[2]  $V_{CCI}$  is the supply voltage associated with the data input port.

[3] For I/O ports, the parameter I<sub>OZ</sub> includes the input leakage current.

#### Table 8. Static characteristics [1][2]

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	–40 °C to	+85 °C	–40 °C to	+125 °C	Unit
			Min	Max	Min	Max	
	HIGH-level	data input					
	input voltage	$V_{CCI} = 0.8 V$	0.70V <sub>CCI</sub>	-	0.70V <sub>CCI</sub>	-	V
		$V_{CCI} = 1.1 \text{ V to } 1.95 \text{ V}$	0.65V <sub>CCI</sub>	-	$0.65V_{CCI}$	-	V
		$V_{CCI} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$	1.6	-	1.6	-	V
		$V_{CCI} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2	-	2	-	V
		DIR input					
		$V_{CC(A)} = 0.8 V$	0.70V <sub>CC(A)</sub>	-	0.70V <sub>CC(A)</sub>	-	V
		$V_{CC(A)} = 1.1 \text{ V to } 1.95 \text{ V}$	$0.65V_{CC(A)}$	-	0.65V <sub>CC(A)</sub>	-	V
		$V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$	1.6	-	1.6	-	V
		$V_{CC(A)} = 3.0 \text{ V to } 3.6 \text{ V}$	2	-	2	-	V

# 74AVC1T45

### Dual-supply voltage level translator/transceiver; 3-state

Symbol	Parameter	Conditions	–40 °C t	o +85 °C	–40 °C to	Unit	
			Min	Max	Min	Max	
V <sub>IL</sub>	LOW-level	data input					
	input voltage	$V_{CCI} = 0.8 V$	-	0.30V <sub>CCI</sub>	-	0.30V <sub>CCI</sub>	V
		$V_{CCI} = 1.1 \text{ V to } 1.95 \text{ V}$	-	0.35V <sub>CCI</sub>	-	0.35V <sub>CCI</sub>	V
		$V_{CCI} = 2.3 \text{ V}$ to 2.7 V	-	0.7	-	0.7	V
		$V_{CCI} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	0.9	-	0.9	V
		DIR input					
		$V_{CC(A)} = 0.8 V$	-	0.30V <sub>CC(A)</sub>	-	0.30V <sub>CC(A)</sub>	V
		$V_{CC(A)} = 1.1 \text{ V to } 1.95 \text{ V}$	-	0.35V <sub>CC(A)</sub>	-	0.35V <sub>CC(A)</sub>	V
		$V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$	-	0.7	-	0.7	V
		$V_{CC(A)} = 3.0 \text{ V to } 3.6 \text{ V}$	-	0.9	-	0.9	V
V <sub>OH</sub>	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$					
		$I_{O} = -100 \ \mu A;$ $V_{CC(A)} = V_{CC(B)} = 0.8 \ V \text{ to } 3.6 \ V$	V <sub>CCO</sub> – 0.1	-	V <sub>CCO</sub> - 0.1	-	V
		$I_O = -3 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 1.1 \text{ V}$	0.85	-	0.85	-	V
		$I_{O} = -6 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 1.4 \text{ V}$	1.05	-	1.05	-	V
		$I_{O} = -8 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 1.65 \text{ V}$	1.2	-	1.2	-	V
		$I_{O} = -9 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 2.3 \text{ V}$	1.75	-	1.75	-	V
		$I_{O} = -12 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 3.0 \text{ V}$	2.3	-	2.3	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$					
	output voltage	$I_{O} = 100 \ \mu A;$ $V_{CC(A)} = V_{CC(B)} = 0.8 \ V \text{ to } 3.6 \ V$	-	0.1	-	0.1	V
		$I_O = 3 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 1.1 \text{ V}$	-	0.25	-	0.25	V
		$I_{O} = 6 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 1.4 \text{ V}$	-	0.35	-	0.35	V
		$I_{O} = 8 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 1.65 \text{ V}$	-	0.45	-	0.45	V
		$I_{O} = 9 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 2.3 \text{ V}$	-	0.55	-	0.55	V
		$I_{O} = 12 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 3.0 \text{ V}$	-	0.7	-	0.7	V
lı	input leakage current	DIR input; $V_I = 0$ V or 3.6 V; $V_{CC(A)} = V_{CC(B)} = 0.8$ V to 3.6 V	-	±1	-	±1.5	μΑ
l <sub>oz</sub>	OFF-state output current		[3] -	±5	-	±7.5	μΑ
I <sub>OFF</sub>	power-off leakage	A port; V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC(A)</sub> = 0 V; V <sub>CC(B)</sub> = 0.8 V to 3.6 V	-	±5	-	±35	μΑ
	current	B port; V <sub>1</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC(B)</sub> = 0 V; V <sub>CC(A)</sub> = 0.8 V to 3.6 V	-	±5	-	±35	μΑ

### Table 8. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

### Dual-supply voltage level translator/transceiver; 3-state

### Table 8. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °C to	o +85 ℃	–40 °C to	+125 °C	Unit
			Min	Max	Min	Max	
I <sub>CC</sub>	supply current	A port; $V_I = 0$ V or $V_{CCI}$ ; $I_O = 0$ A		'			
		$V_{CC(A)} = 0.8 V \text{ to } 3.6 V;$ $V_{CC(B)} = 0.8 V \text{ to } 3.6 V$	-	8	-	12	μA
		$V_{CC(A)} = 3.6 \text{ V}; V_{CC(B)} = 0 \text{ V}$	-	8	-	12	μΑ
		$V_{CC(A)} = 0 V; V_{CC(B)} = 3.6 V$	-2	-	-8	-	μA
		B port; $V_I = 0$ V or $V_{CCI}$ ; $I_O = 0$ A					
		$V_{CC(A)} = 0.8 V \text{ to } 3.6 V;$ $V_{CC(B)} = 0.8 V \text{ to } 3.6 V$	-	8	-	12	μA
		$V_{CC(A)} = 3.6 \text{ V}; V_{CC(B)} = 0 \text{ V}$	-2	-	-8	-	μA
		$V_{CC(A)} = 0 V; V_{CC(B)} = 3.6 V$	-	8	-	12	μA
		A plus B port ( $I_{CC(A)} + I_{CC(B)}$ ); $I_{O} = 0 A$ ; $V_{I} = 0 V \text{ or } V_{CCI}$ ; $V_{CC(A)} = 0.8 V \text{ to } 3.6 V$ ; $V_{CC(B)} = 0.8 V \text{ to } 3.6 V$	-	16	-	24	μΑ

[1]  $V_{CCO}$  is the supply voltage associated with the output port.

[2]  $V_{CCI}$  is the supply voltage associated with the data input port.

[3] For I/O ports, the parameter  $I_{OZ}$  includes the input leakage current.

Dual-supply voltage level translator/transceiver; 3-state

### **11. Dynamic characteristics**

### Table 9. Typical dynamic characteristics at $V_{CC(A)} = 0.8$ V and $T_{amb} = 25$ °C [1]

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8; for wave forms see Figure 6 and Figure 7

Symbol	Parameter	Conditions	V <sub>CC(B)</sub>						Unit
			0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
t <sub>pd</sub>	propagation delay	A to B	15.5	8.1	7.6	7.7	8.4	9.2	ns
		B to A	15.5	12.7	12.3	12.2	12.0	11.8	ns
t <sub>dis</sub>	disable time	DIR to A	12.2	12.2	12.2	12.2	12.2	12.2	ns
		DIR to B	11.7	7.9	7.6	8.2	8.7	10.2	ns
t <sub>en</sub>	enable time	DIR to A	27.2	20.6	19.9	20.4	20.7	22.0	ns
		DIR to B	27.7	20.3	19.8	19.9	20.6	21.4	ns

[1] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>; t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>; t<sub>en</sub> is the same as t<sub>PZL</sub> and t<sub>PZH</sub>. t<sub>en</sub> is a calculated value using the formula shown in Section 13.4 "Enable times"

# Table 10. Typical dynamic characteristics at $V_{CC(B)} = 0.8$ V and $T_{amb} = 25 \text{ °C}$ [1]

Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 8</u>; for wave forms see <u>Figure 6</u> and <u>Figure 7</u>

Symbol	Parameter	Conditions	V <sub>CC(A)</sub>						Unit
			0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
t <sub>pd</sub>	t <sub>pd</sub> propagation delay	A to B	15.5	12.7	12.3	12.2	12.0	11.8	ns
		B to A	15.5	8.1	7.6	7.7	8.4	9.2	ns
t <sub>dis</sub>	disable time	DIR to A	12.2	4.9	3.8	3.7	2.8	3.4	ns
		DIR to B	11.7	9.2	9.0	8.8	8.7	8.6	ns
t <sub>en</sub>	enable time	DIR to A	27.2	17.3	16.6	16.5	17.1	17.8	ns
		DIR to B	27.7	17.6	16.1	15.9	14.8	15.2	ns

[1] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>; t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>; t<sub>en</sub> is the same as t<sub>PZL</sub> and t<sub>PZH</sub>. t<sub>en</sub> is a calculated value using the formula shown in Section 13.4 "Enable times"

Table 11.	Typical power dissipation capacitance at $V_{CC(A)} = V_{CC(B)}$ and $T_{amb} = 25 \text{ °C} \frac{[1][2]}{2}$
Voltages a	re referenced to $GND$ (ground = 0 V).

Symbol	Parameter	Conditions	$V_{CC(A)}$ and $V_{CC(B)}$						
		0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V		
C <sub>PD</sub>	power dissipation capacitance	A port: (direction A to B); B port: (direction B to A)	1	2	2	2	2	2	pF
		A port: (direction B to A); B port: (direction A to B)	9	11	11	12	14	17	pF

[1]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

f<sub>i</sub> = input frequency in MHz;

 $f_o = output frequency in MHz;$ 

 $C_L$  = load capacitance in pF;

 $V_{CC}$  = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$  = sum of the outputs.

[2]  $f_i = 10 \text{ MHz}$ ;  $V_I = \text{GND}$  to  $V_{\text{CC}}$ ;  $t_r = t_f = 1 \text{ ns}$ ;  $C_L = 0 \text{ pF}$ ;  $R_L = \infty \Omega$ .

# 74AVC1T45

### Dual-supply voltage level translator/transceiver; 3-state

Current and		I to GND (ground = 0 V); for test circuit see <u>Figure 8</u> ; for wave forms see <u>Figure 6</u> and <u>Figure 7</u> .									-		
Symbol	Parameter	Conditions	V <sub>CC(B)</sub>		1						1		Unit
			1.2 V :	± 0.1 V	1.5 V :	± 0.1 V	1.8 V ±	0.15 V	2.5 V :	± 0.2 V	3.3 V :	± 0.3 V	
			Min	Max	Min	Max	Min	Мах	Min	Max	Min	Max	
$V_{CC(A)} =$	1.1 V to 1.3 V												
t <sub>pd</sub>	propagation	A to B	1.0	9.0	0.7	6.8	0.6	6.1	0.5	5.7	0.5	6.1	ns
	delay	B to A	1.0	9.0	0.8	8.0	0.7	7.7	0.6	7.2	0.5	7.1	ns
t <sub>dis</sub>	disable time	DIR to A	2.2	8.8	2.2	8.8	2.2	8.8	2.2	8.8	2.2	8.8	ns
		DIR to B	2.2	8.4	1.8	6.7	2.0	6.9	1.7	6.2	2.4	7.2	ns
t <sub>en</sub>	enable time	DIR to A	-	17.4	-	14.7	-	14.6	-	13.4	-	14.3	ns
		DIR to B	-	17.8	-	15.6	-	14.9	-	14.5	-	14.9	ns
$V_{CC(A)} =$	1.4 V to 1.6 V												
t <sub>pd</sub>	propagation	A to B	1.0	8.0	0.7	5.4	0.6	4.6	0.5	3.7	0.5	3.5	ns
	delay	B to A	1.0	6.8	0.8	5.4	0.7	5.1	0.6	4.7	0.5	4.5	ns
t <sub>dis</sub> disable time	DIR to A	1.6	6.3	1.6	6.3	1.6	6.3	1.6	6.3	1.6	6.3	ns	
		DIR to B	2.0	7.6	1.8	5.9	1.6	6.0	1.2	4.8	1.7	5.5	ns
t <sub>en</sub>	enable time	DIR to A	-	14.4	-	11.3	-	11.1	-	9.5	-	10.0	ns
		DIR to B	-	14.3	-	11.7	-	10.9	-	10.0	-	9.8	ns
$V_{CC(A)} =$	1.65 V to 1.95	V											
t <sub>pd</sub>	pd propagation delay	A to B	1.0	7.7	0.6	5.1	0.5	4.3	0.5	3.4	0.5	3.1	ns
		B to A	1.0	6.1	0.7	4.6	0.5	4.4	0.5	3.9	0.5	3.7	ns
t <sub>dis</sub>	disable time	DIR to A	1.6	5.5	1.6	5.5	1.6	5.5	1.6	5.5	1.6	5.5	ns
		DIR to B	1.8	7.7	1.8	5.7	1.4	5.8	1.0	4.5	1.5	5.2	ns
t <sub>en</sub>	enable time	DIR to A	-	13.8	-	10.3	-	10.2	-	8.4	-	8.9	ns
		DIR to B	-	13.2	-	10.6	-	9.8	-	8.9	-	8.6	ns
$V_{CC(A)} =$	2.3 V to 2.7 V												
t <sub>pd</sub>	propagation	A to B	1.0	7.2	0.5	4.7	0.5	3.9	0.5	3.0	0.5	2.6	ns
	delay	B to A	1.0	5.7	0.6	3.8	0.5	3.4	0.5	3.0	0.5	2.8	ns
t <sub>dis</sub>	disable time	DIR to A	1.5	4.2	1.5	4.2	1.5	4.2	1.5	4.2	1.5	4.2	ns
		DIR to B	1.7	7.3	2.0	5.2	1.5	5.1	0.6	4.2	1.1	4.8	ns
t <sub>en</sub>	enable time	DIR to A	-	13.0	-	9.0	-	8.5	-	7.2	-	7.6	ns
		DIR to B	-	11.4	-	8.9	-	8.1	-	7.2	-	6.8	ns
$V_{CC(A)} =$	3.0 V to 3.6 V												
t <sub>pd</sub>	propagation	A to B	1.0	7.1	0.5	4.5	0.5	3.7	0.5	2.8	0.5	2.4	ns
F. ~	delay	B to A	1.0	6.1	0.6	3.6	0.5	3.1	0.5	2.6	0.5	2.4	ns
t <sub>dis</sub>	disable time	DIR to A	1.5	4.7	1.5	4.7	1.5	4.7	1.5	4.7	1.5	4.7	ns
310		DIR to B	1.7	7.2	0.7	5.5	0.6	5.5	0.7	4.1	1.7	4.7	ns
t <sub>en</sub>	enable time	DIR to A	-	13.3	-	9.1	-	8.6	-	6.7	-	7.1	ns
-611	2	DIR to B	-	11.8	-	9.2	-	8.4	-	7.5	-	7.1	ns

# Table 12. Dynamic characteristics for temperature range -40 °C to +85 °C [1] Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8; for way

fr ~ 

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ ;  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ ;  $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .  $t_{en}$  is a calculated value using the formula shown in <u>Section 13.4 "Enable times"</u>

74AVC1T45 **Product data sheet** 

# 74AVC1T45

### Dual-supply voltage level translator/transceiver; 3-state

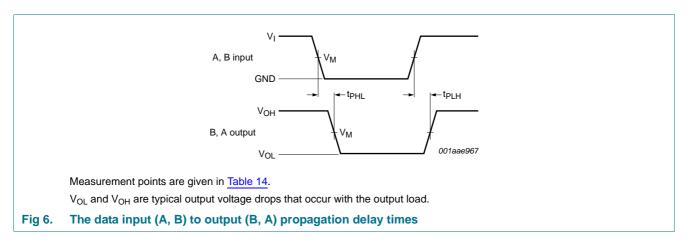
Symbol	Parameter	Conditions	V <sub>CC(B)</sub>							Un			
			1.2 V	± 0.1 V	1.5 V :	± 0.1 V	1.8 V ±	0.15 V	2.5 V :	± 0.2 V	3.3 V :	± 0.3 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
V <sub>CC(A)</sub> =	1.1 V to 1.3 V												
pd	propagation	A to B	1.0	9.9	0.7	7.5	0.6	6.8	0.5	6.3	0.5	6.8	ns
	delay	B to A	1.0	9.9	0.8	8.8	0.7	8.5	0.6	8.0	0.5	7.9	ns
t <sub>dis</sub>	disable time	DIR to A	2.2	9.7	2.2	9.7	2.2	9.7	2.2	9.7	2.2	9.7	ns
	DIR to B	2.2	9.2	1.8	7.4	2.0	7.6	1.7	6.9	2.4	8.0	ns	
t <sub>en</sub>	enable time	DIR to A	-	19.1	-	16.2	-	16.1	-	14.9	-	15.9	ns
		DIR to B	-	19.6	-	17.2	-	16.5	-	16.0	-	16.5	ns
$V_{CC(A)} =$	1.4 V to 1.6 V												
pd	propagation	A to B	1.0	8.8	0.7	6.0	0.6	5.1	0.5	4.1	0.5	3.9	ns
	delay	B to A	1.0	7.5	0.8	6.0	0.7	5.7	0.6	5.2	0.5	5.0	ns
t <sub>dis</sub> disable time	DIR to A	1.6	7.0	1.6	7.0	1.6	7.0	1.6	7.0	1.6	7.0	ns	
		DIR to B	2.0	8.3	1.8	6.5	1.6	6.6	1.2	5.3	1.7	6.1	ns
t <sub>en</sub> enable time	enable time	DIR to A	-	15.8	-	12.5	-	12.3	-	10.5	-	11.1	ns
		DIR to B	-	15.8	-	13.0	-	12.1	-	11.1	-	10.9	ns
$V_{CC(A)} =$	1.65 V to 1.95	V											
pd propagation	A to B	1.0	8.5	0.6	5.7	0.5	4.8	0.5	3.8	0.5	3.5	ns	
	delay	B to A	1.0	6.8	0.7	5.1	0.5	4.9	0.5	4.3	0.5	4.1	ns
t <sub>dis</sub>	disable time	DIR to A	1.6	6.1	1.6	6.1	1.6	6.1	1.6	6.1	1.6	6.1	ns
		DIR to B	1.8	8.5	1.8	6.3	1.4	6.4	1.0	5.0	1.5	5.8	ns
t <sub>en</sub>	enable time	DIR to A	-	15.3	-	11.4	-	11.3	-	9.3	-	9.9	ns
		DIR to B	-	14.6	-	11.8	-	10.9	-	9.9	-	9.6	ns
$V_{CC(A)} =$	2.3 V to 2.7 V												
t <sub>pd</sub>	propagation	A to B	1.0	8.0	0.5	5.2	0.5	4.3	0.5	3.3	0.5	2.9	ns
	delay	B to A	1.0	6.3	0.6	4.2	0.5	3.8	0.5	3.3	0.5	3.1	ns
t <sub>dis</sub>	disable time	DIR to A	1.5	4.7	1.5	4.7	1.5	4.7	1.5	4.7	1.5	4.7	ns
		DIR to B	1.7	8.0	2.0	5.8	1.5	5.7	0.6	4.7	1.1	5.3	ns
t <sub>en</sub>	enable time	DIR to A	-	14.3	-	10.0	-	9.5	-	8.0	-	8.4	ns
		DIR to B	-	12.7	-	9.9	-	9.0	-	8.0	-	7.6	ns
$V_{CC(A)} =$	3.0 V to 3.6 V												
pd	propagation	A to B	1.0	7.9	0.5	5.0	0.5	4.1	0.5	3.1	0.5	2.7	ns
•	delay	B to A	1.0	6.8	0.6	4.0	0.5	3.5	0.5	2.9	0.5	2.7	ns
t <sub>dis</sub>	disable time	DIR to A	1.5	5.2	1.5	5.2	1.5	5.2	1.5	5.2	1.5	5.2	ns
		DIR to B	1.7	7.9	0.7	6.1	0.6	6.1	0.7	4.6	1.7	5.2	ns
t <sub>en</sub>	enable time	DIR to A	-	14.7	-	10.1	-	9.6	-	7.5	-	7.9	ns
		DIR to B	-	13.1	-	10.2	-	9.3	-	8.3	-	7.9	ns

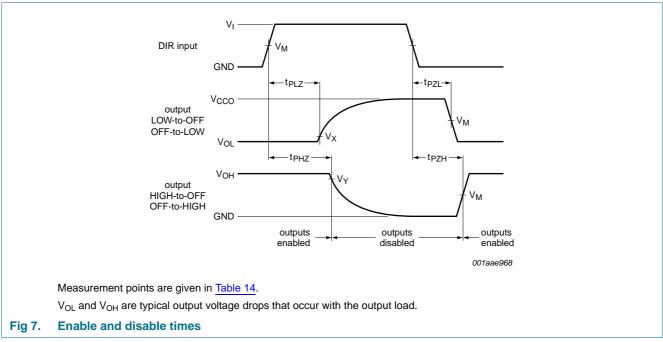
### Table 13. Dynamic characteristics for temperature range -40 °C to +125 °C [1]

74AVC1T45 **Product data sheet** 

Dual-supply voltage level translator/transceiver; 3-state

### 12. Waveforms





#### Table 14. Measurement points

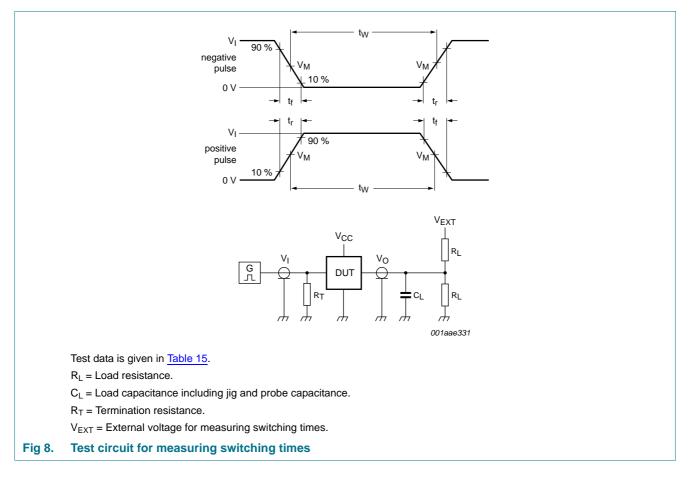
Supply voltage	Input <sup>[1]</sup>	Output <sup>[2]</sup>	Output <sup>[2]</sup>				
V <sub>CC(A)</sub> , V <sub>CC(B)</sub>	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>			
1.1 V to 1.6 V	0.5V <sub>CCI</sub>	0.5V <sub>CCO</sub>	V <sub>OL</sub> + 0.1 V	V <sub>OH</sub> – 0.1 V			
1.65 V to 2.7 V	0.5V <sub>CCI</sub>	0.5V <sub>CCO</sub>	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V			
3.0 V to 3.6 V	0.5V <sub>CCI</sub>	$0.5V_{CCO}$	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> – 0.3 V			

[1]  $V_{CCI}$  is the supply voltage associated with the data input port.

[2]  $V_{CCO}$  is the supply voltage associated with the output port.

# 74AVC1T45

### Dual-supply voltage level translator/transceiver; 3-state



#### Table 15. Test data

Supply voltage Input		Load		V <sub>EXT</sub>	V <sub>EXT</sub>		
V <sub>CC(A)</sub> , V <sub>CC(B)</sub>	V <mark>[<sup>1]</sup></mark>	∆t/∆V[2]	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub> [3]
1.1 V to 1.6 V	V <sub>CCI</sub>	$\leq$ 1.0 ns/V	15 pF	2 kΩ	open	GND	2V <sub>CCO</sub>
1.65 V to 2.7 V	V <sub>CCI</sub>	$\leq$ 1.0 ns/V	15 pF	2 kΩ	open	GND	2V <sub>CCO</sub>
3.0 V to 3.6 V	V <sub>CCI</sub>	$\leq$ 1.0 ns/V	15 pF	2 kΩ	open	GND	2V <sub>CCO</sub>

[1] V<sub>CCI</sub> is the supply voltage associated with the data input port.

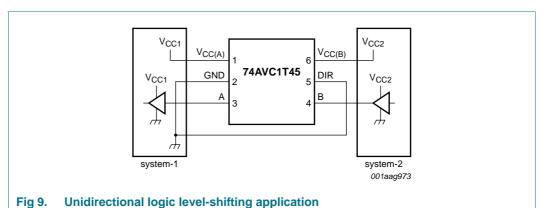
[2]  $dV/dt \ge 1.0 V/ns$ 

[3]  $V_{CCO}$  is the supply voltage associated with the output port.

### **13. Application information**

### 13.1 Unidirectional logic level-shifting application

The circuit given in Figure 9 is an example of the 74AVC1T45 being used in an unidirectional logic level-shifting application.



#### Table 16. Description unidirectional logic level-shifting application

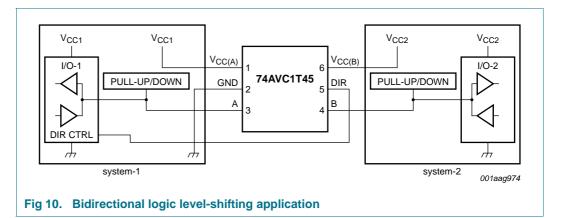
Pin	Name	Function	Description
1	V <sub>CC(A)</sub>	V <sub>CC1</sub>	supply voltage of system-1 (0.8 V to 3.6 V)
2	GND	GND	device GND
3	А	OUT	output level depends on V <sub>CC1</sub> voltage
4	DIR	DIR	the GND (LOW level) determines B port to A port direction
5	В	IN	input threshold value depends on $V_{CC2}$ voltage
6	V <sub>CC(B)</sub>	V <sub>CC2</sub>	supply voltage of system-2 (0.8 V to 3.6 V)
-			

13 of 23

### Dual-supply voltage level translator/transceiver; 3-state

### 13.2 Bidirectional logic level-shifting application

<u>Figure 10</u> shows the 74AVC1T45 being used in a bidirectional logic level-shifting application. Since the device does not have an output enable pin, the system designer should take precautions to avoid bus contention between system-1 and system-2 when changing directions.



<u>Table 17</u> gives a sequence that will illustrate data transmission from system-1 to system-2 and then from system-2 to system-1.

				• • • • • • • • • • • • • • • • • • • •
State	DIR CTRL	I/O-1	I/O-2	Description
1	Н	output	input	system-1 data to system-2
2	Η	Z	Z	system-2 is getting ready to send data to system-1. I/O-1 and I/O-2 are disabled. The bus-line state depends on bus hold.
3	L	Z	Z	DIR bit is set LOW. I/O-1 and I/O-2 still are disabled. The bus-line state depends on bus hold.
4	L	input	output	system-2 data to system-1

### Table 17. Description bidirectional logic level-shifting application<sup>[1]</sup>

[1] H = HIGH voltage level;

L = LOW voltage level;

Z = high-impedance OFF-state.

#### Dual-supply voltage level translator/transceiver; 3-state

### 13.3 Power-up considerations

The device is designed such that no special power-up sequence is required other than GND being applied first.

V <sub>CC(A)</sub>	V <sub>CC(B)</sub>	V <sub>CC(B)</sub>								
	0 V	0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V			
0 V	0	0.1	0.1	0.1	0.1	0.1	0.1	μA		
0.8 V	0.1	0.1	0.1	0.1	0.1	0.7	2.3	μΑ		
1.2 V	0.1	0.1	0.1	0.1	0.1	0.3	1.4	μA		
1.5 V	0.1	0.1	0.1	0.1	0.1	0.1	0.9	μA		
1.8 V	0.1	0.1	0.1	0.1	0.1	0.1	0.5	μA		
2.5 V	0.1	0.7	0.3	0.1	0.1	0.1	0.1	μΑ		
3.3 V	0.1	2.3	1.4	0.9	0.5	0.1	0.1	μΑ		

Table 18. Typical total supply current (I<sub>CC(A)</sub> + I<sub>CC(B)</sub>)

### 13.4 Enable times

Calculate the enable times for the 74AVC1T45 using the following formulas:

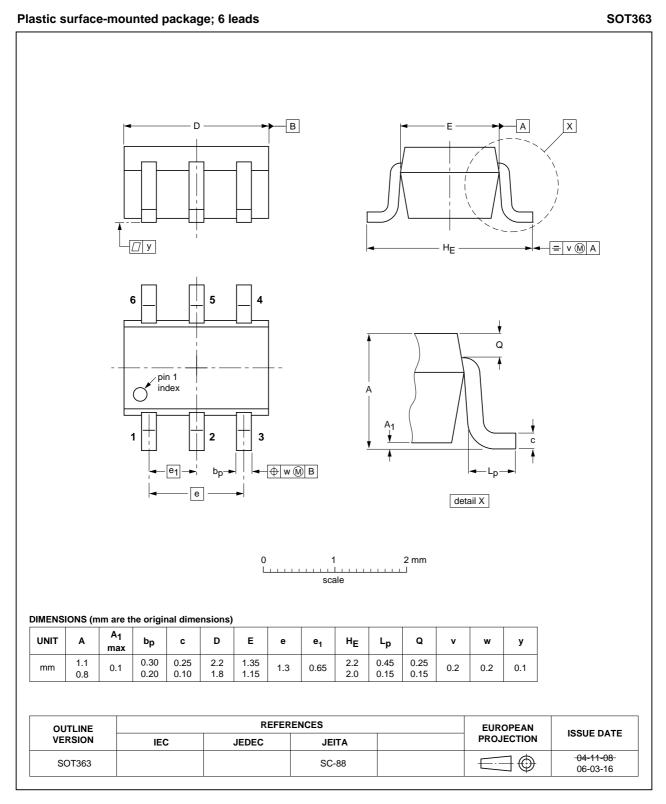
- $t_{en}$  (DIR to A) =  $t_{dis}$  (DIR to B) +  $t_{pd}$  (B to A)
- $t_{en}$  (DIR to B) =  $t_{dis}$  (DIR to A) +  $t_{pd}$  (A to B)

In a bidirectional application, these enable times provide the maximum delay from the time the DIR bit is switched until an output is expected. For example, if the 74AVC1T45 initially is transmitting from A to B, then the DIR bit is switched, the B port of the device must be disabled before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.

# 74AVC1T45

Dual-supply voltage level translator/transceiver; 3-state

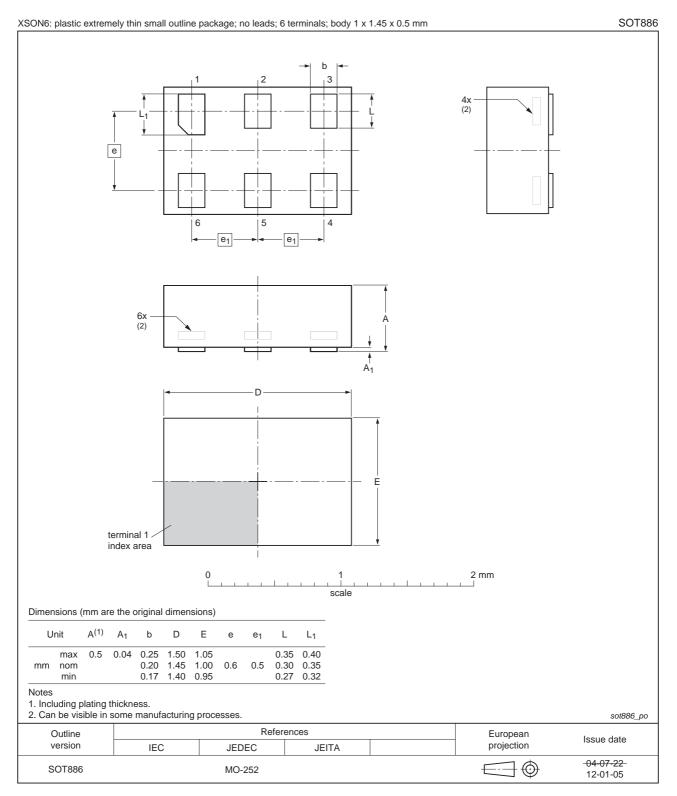
### 14. Package outline



### Fig 11. Package outline SOT363 (SC-88)

All information provided in this document is subject to legal disclaimers.

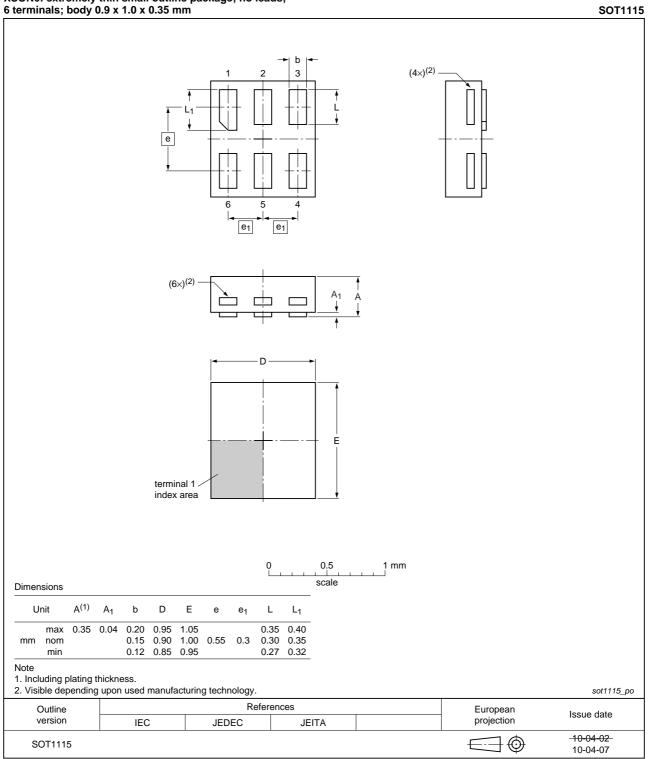
#### Dual-supply voltage level translator/transceiver; 3-state



### Fig 12. Package outline SOT886 (XSON6)

All information provided in this document is subject to legal disclaimers.

Dual-supply voltage level translator/transceiver; 3-state



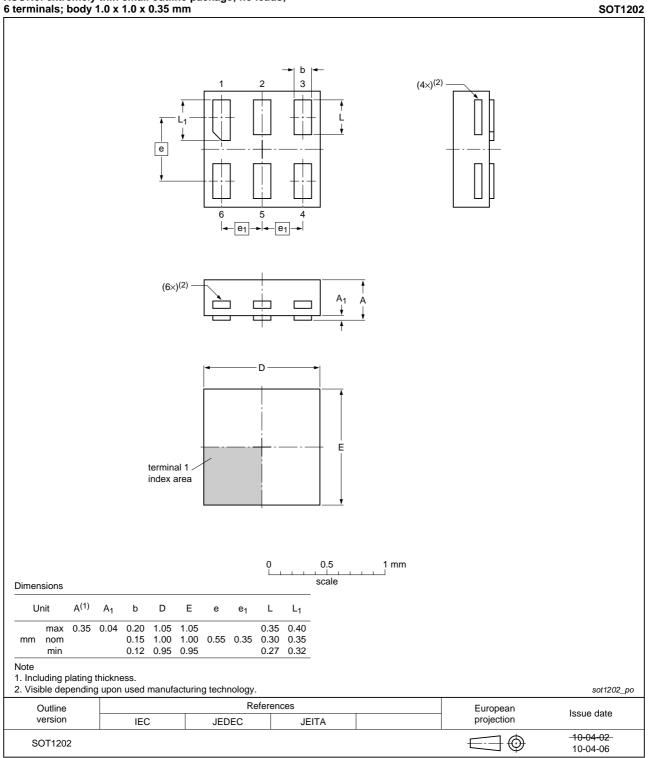
#### XSON6: extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm

Fig 13. Package outline SOT1115 (XSON6)

74AVC1T45

18 of 23

Dual-supply voltage level translator/transceiver; 3-state



XSON6: extremely thin small outline package; no leads; 6 terminals; body 1.0 x 1.0 x 0.35 mm

Fig 14. Package outline SOT1202 (XSON6)

19 of 23

Dual-supply voltage level translator/transceiver; 3-state

# **15. Abbreviations**

Acronym	Description
	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

# 16. Revision history

Table 20. Revision hist	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74AVC1T45 v.4	20120622	Product data sheet	-	74AVC1T45 v.3
Modifications:	<ul> <li>Package outli</li> </ul>	ine drawing of SOT886 (Figur	e 12) modified.	
74AVC1T45 v.3	20111021	Product data sheet	-	74AVC1T45 v.2
Modifications:	<ul> <li>Added type n</li> </ul>	umber 74AVC1T45GN (SOT1	115/XSON6 package).	
	<ul> <li>Added type n</li> </ul>	umber 74AVC1T45GS (SOT1	202/XSON6 package)	
74AVC1T45 v.2	20090505	Product data sheet	-	74AVC1T45 v.1
74AVC1T45 v.1	20080118	Product data sheet	-	-

Dual-supply voltage level translator/transceiver; 3-state

### 17. Legal information

### **17.1 Data sheet status**

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

### 17.2 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

### 17.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product sole and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

© NXP B.V. 2012. All rights reserved.

#### Dual-supply voltage level translator/transceiver; 3-state

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

**Non-automotive qualified products** — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

# NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

**Translations** — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

### 17.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

### **18. Contact information**

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

# 74AVC1T45

Dual-supply voltage level translator/transceiver; 3-state

### **19. Contents**

1	General description 1
2	Features and benefits 1
3	Ordering information 2
4	Marking 2
5	Functional diagram 2
6	Pinning information 3
6.1	Pinning 3
6.2	Pin description 3
7	Functional description 3
8	Limiting values 4
9	Recommended operating conditions 4
10	Static characteristics 5
11	Dynamic characteristics 8
12	Waveforms 11
13	Application information 13
<b>13</b> 13.1	Application information.13Unidirectional logic level-shifting application13
13.1 13.2	
13.1 13.2 13.3	Unidirectional logic level-shifting application . 13 Bidirectional logic level-shifting application 14 Power-up considerations
13.1 13.2	Unidirectional logic level-shifting application . 13 Bidirectional logic level-shifting application 14
13.1 13.2 13.3	Unidirectional logic level-shifting application . 13 Bidirectional logic level-shifting application 14 Power-up considerations
13.1 13.2 13.3 13.4	Unidirectional logic level-shifting application . 13Bidirectional logic level-shifting application 14Power-up considerations
13.1 13.2 13.3 13.4 <b>14</b>	Unidirectional logic level-shifting application13Bidirectional logic level-shifting application14Power-up considerations15Enable times15Package outline16
13.1 13.2 13.3 13.4 14 15	Unidirectional logic level-shifting application13Bidirectional logic level-shifting application14Power-up considerations15Enable times15Package outline16Abbreviations20Revision history20
13.1 13.2 13.3 13.4 14 15 16	Unidirectional logic level-shifting application13Bidirectional logic level-shifting application14Power-up considerations15Enable times15Package outline16Abbreviations20
13.1 13.2 13.3 13.4 14 15 16 17	Unidirectional logic level-shifting application13Bidirectional logic level-shifting application14Power-up considerations15Enable times15Package outline16Abbreviations20Revision history20Legal information21
13.1 13.2 13.3 13.4 <b>14</b> <b>15</b> <b>16</b> <b>17</b> 17.1 17.2 17.3	Unidirectional logic level-shifting application13Bidirectional logic level-shifting application14Power-up considerations15Enable times15Package outline16Abbreviations20Revision history20Legal information21Data sheet status21
13.1 13.2 13.3 13.4 <b>14</b> <b>15</b> <b>16</b> <b>17</b> 17.1 17.2	Unidirectional logic level-shifting application13Bidirectional logic level-shifting application14Power-up considerations15Enable times15Package outline16Abbreviations20Revision history20Legal information21Data sheet status21Definitions21
13.1 13.2 13.3 13.4 <b>14</b> <b>15</b> <b>16</b> <b>17</b> 17.1 17.2 17.3	Unidirectional logic level-shifting application13Bidirectional logic level-shifting application14Power-up considerations15Enable times15Package outline16Abbreviations20Revision history20Legal information21Data sheet status21Definitions21Disclaimers21

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

#### © NXP B.V. 2012.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 22 June 2012 Document identifier: 74AVC1T45